

#### 3A SBR® **SUPER BARRIER RECTIFIER**

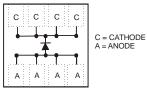
#### **Features**

- Ultra Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound Device (Note 2)



#### **Mechanical Data**

- Case: DFN3030-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish NiPdAu annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208 @3
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.0172 grams (approximate)



A = ANODE

Top View

# **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$		
Working Peak Reverse Voltage	$V_{RWM}$	150	V
DC Blocking Voltage	$V_{RM}$		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	106	V
Average Rectified Output Current (See Figure 1)	Ιο	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	33	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Ambient (Note 3) @ T <sub>A</sub> = 25°C	$R_{ heta JA}$	60	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

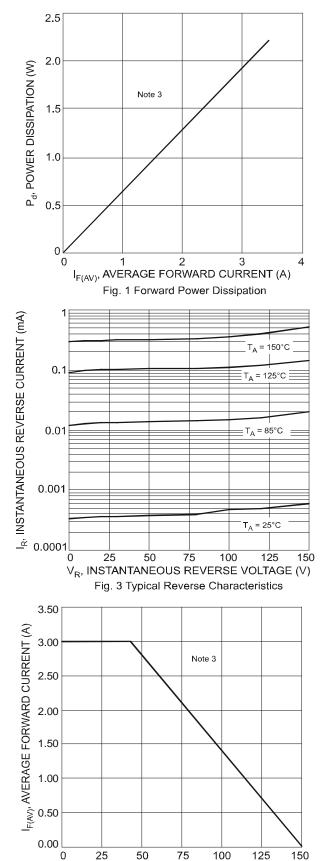
# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

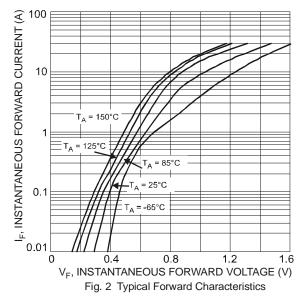
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 4)	$V_{(BR)R}$	150	-	=	V	$I_R = 2mA$
Forward Voltage	V <sub>F</sub>	-	-	0.91	V	$I_F = 3.0A, T_J = 25^{\circ}C$
Reverse Current (Note 4)	I <sub>R</sub>	-	-	2	mA	$V_R = 150V, T_J = 25^{\circ}C$

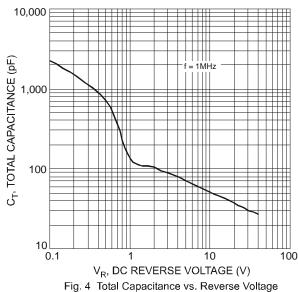
Notes:

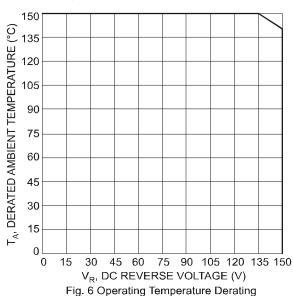
- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php
- 3. Device mounted on polymide substrate, 2oz. Copper, 75mm² pad area, double side PCB.
- 4. Short duration pulse test used to minimize self-heating effect.











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T<sub>A</sub>, AMBIENT TEMPERATURE (°C)

Fig. 5 Forward Current Derating Curve



#### Ordering Information (Note 5)

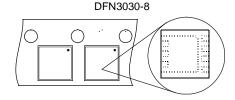
Part Number	Case	Packaging
SBR3U150LP-7	DFN3030-8	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

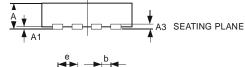
### **Marking Information**

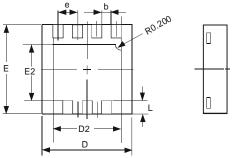


SVB = Product marking code YYWW = Date code marking YY = Last digit of year ex: 06 for 2006 WW = Week code 01 to 52



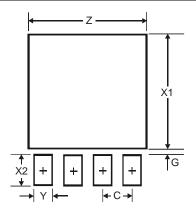
## **Package Outline Dimensions**





DFN3030-8				
Dim	Min	Max	Тур	
Α	0.57	0.63	0.60	
A1	0	0.05	0.02	
A3			0.15	
b	0.29	0.39	0.34	
D	2.90	3.10	3.00	
D2	2.19	2.39	2.29	
е			0.65	
Е	2.90	3.10	3.00	
E2	1.64	1.84	1.74	
L	0.30	0.60	0.45	
All Dimensions in mm				

# Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.59
G	0.11
X1	2.49
X2	0.65
Υ	0.39
С	0.65

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